

# **N-Channel Power MOSFET**

600V, 10A,  $0.75\Omega$ 

#### **FEATURES**

- High power and current handling capability
- Pb-free plating
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

| KEY PERFORMANCE PARAMETERS |       |      |  |
|----------------------------|-------|------|--|
| PARAMETER                  | VALUE | UNIT |  |
| $V_{DS}$                   | 600   | V    |  |
| R <sub>DS(on)</sub> (max)  | 0.75  | Ω    |  |
| Q <sub>g</sub>             | 39    | nC   |  |



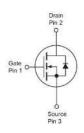




#### **APPLICATION**

- Power Supply
- Lighting





| ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted) |                        |                                   |              |      |
|--|------------------------|-----------------------------------|--------------|------|
| PARAMETER  |                        | SYMBOL                            | Limit        | UNIT |
| Drain-Source Voltage   |                        | V <sub>DS</sub>                   | 600          | ٧    |
| Gate-Source Voltage  |                        | V <sub>GS</sub>                   | ±30          | V    |
| Continuous Drain Current (Note 1)  | T <sub>C</sub> = 25°C  | I <sub>D</sub>                    | 10           | Α    |
|  | T <sub>C</sub> = 100°C |                                   | 7.7          | Α    |
| Pulsed Drain Current (Note 2)  |                        | I <sub>DM</sub>                   | 30           | Α    |
| Total Power Dissipation @ T <sub>C</sub> = 25°C                          |                        | P <sub>DTOT</sub>                 | 50           | W    |
| Single Pulsed Avalanche Energy (Note 3)                                  |                        | E <sub>AS</sub>                   | 37.5         | mJ   |
| Single Pulsed Avalanche Current (Note                                    | e 3)                   | I <sub>AS</sub>                   | 10           | Α    |
| Operating Junction and Storage Tem                                       | perature Range         | T <sub>J</sub> , T <sub>STG</sub> | - 55 to +150 | °C   |

| THERMAL PERFORMANCE                    |                  |       |      |  |
|--|------------------|-------|------|--|
| PARAMETER                              | SYMBOL           | Limit | UNIT |  |
| Junction to Case Thermal Resistance    | R <sub>eJC</sub> | 2.5   | °C/W |  |
| Junction to Ambient Thermal Resistance | $R_{\Theta JA}$  | 62    | °C/W |  |

**Notes:**  $R_{\Theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistances. The case thermal reference is defined at the solder mounting surface of the drain pins.  $R_{\Theta JA}$  is guaranteed by design while  $R_{\Theta CA}$  is determined by the user's board design.  $R_{\Theta JA}$  shown below for single device operation on FR-4 PCB with minimum recommended footprint in still air.

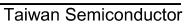


| <b>ELECTRICAL SPECIFICATIONS</b> (T <sub>A</sub> = 25°C unless otherwise noted) |   |                     |     |      |      |      |
|---|---|---------------------|-----|------|------|------|
| PARAMETER   | CONDITIONS  | SYMBOL              | MIN | TYP  | MAX  | UNIT |
| Static (Note 4)   |   |                     |     |      |      |      |
| Drain-Source Breakdown Voltage  | $V_{GS} = 0V, I_D = 250\mu A$                                       | BV <sub>DSS</sub>   | 600 |      |      | V    |
| Gate Threshold Voltage  | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$                                | V <sub>GS(TH)</sub> | 2   |      | 4    | V    |
| Gate Body Leakage   | $V_{GS} = \pm 30V, V_{DS} = 0V$                                     | I <sub>GSS</sub>    |     |      | ±100 | nA   |
| Zero Gate Voltage Drain Current   | $V_{DS} = 600V, V_{GS} = 0V$  | I <sub>DSS</sub>    |     |      | 10   | μA   |
| Drain-Source On-State Resistance  | $V_{GS} = 10V, I_D = 5A$  | R <sub>DS(on)</sub> |     | 0.65 | 0.75 | Ω    |
| Dynamic (Note 5)  |   |                     |     |      |      |      |
| Total Gate Charge   | $V_{DS} = 380V, I_{D} = 10A,$<br>$V_{GS} = 10V$                     | Qg                  |     | 39   |      |      |
| Gate-Source Charge  |   | $Q_gs$              |     | 9    |      | nC   |
| Gate-Drain Charge   |   | $Q_{gd}$            |     | 13   |      |      |
| Input Capacitance   | .,  | C <sub>iss</sub>    |     | 1820 |      |      |
| Output Capacitance  | $V_{DS} = 25V, V_{GS} = 0V,$  | C <sub>oss</sub>    |     | 186  |      | pF   |
| Reverse Transfer Capacitance  | - f = 1.0MHz  | C <sub>rss</sub>    |     | 24   |      |      |
| Gate Resistance   | F = 1MHz, open drain  | $R_g$               |     | 10   |      | Ω    |
| Switching (Note 6)  |   |                     |     |      |      |      |
| Turn-On Delay Time  |   | t <sub>d(on)</sub>  |     | 32   |      |      |
| Turn-On Rise Time   | $V_{DD} = 380V,$ $R_{GEN} = 25\Omega,$ $I_{D} = 10A, V_{GS} = 10V,$ | t <sub>r</sub>      |     | 12   |      |      |
| Turn-Off Delay Time   |   | t <sub>d(off)</sub> |     | 125  |      | ns   |
| Turn-Off Fall Time  | ID - 10A, VGS - 10V,  | t <sub>f</sub>      |     | 27   |      |      |
| Source-Drain Diode (Note 4)   |   |                     |     |      |      |      |
| Forward On Voltage  | I <sub>S</sub> = 10A, V <sub>GS</sub> = 0V                          | V <sub>SD</sub>     |     |      | 1.4  | V    |
| Reverse Recovery Time   | V <sub>R</sub> = 100V, I <sub>S</sub> = 10A                         | t <sub>rr</sub>     |     | 363  |      | ns   |
| Reverse Recovery Charge   | $dI_F/dt = 100A/\mu s$  | Q <sub>rr</sub>     |     | 4.5  |      | μC   |

# Notes:

- 1. Current limited by package.
- 2. Pulse width limited by the maximum junction temperature.
- 3. L = 0.75mH,  $I_{AS}$  = 10A,  $V_{DD}$  = 50V,  $R_G$  = 25 $\Omega$ , Starting  $T_J$  = 25 $^{\circ}$ C
- 4. Pulse test: PW  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
- 5. For DESIGN AID ONLY, not subject to production testing.
- 6. Switching time is essentially independent of operating temperature.

Version: A15





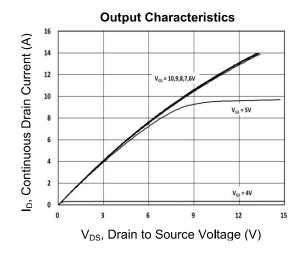
# **ORDERING INFORMATION**

| PART NO.        | PACKAGE | PACKING    |
|-----------------|---------|------------|
| TSM10NB60CI C0G | ITO-220 | 50pcs/Tube |

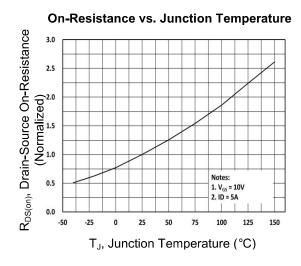


# **CHARACTERISTICS CURVES**

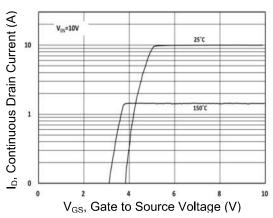
 $(T_C = 25^{\circ}C \text{ unless otherwise noted})$ 



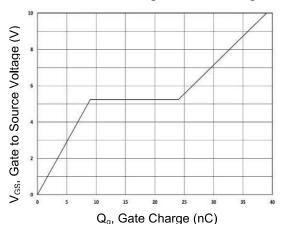
# On-Resistance vs. Drain Current On-Resistance vs. Drain Current



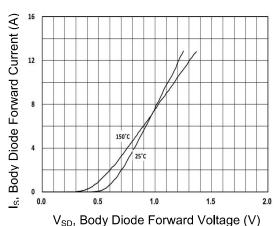




## Gate-Source Voltage vs. Gate Charge



### Source-Drain Diode Forward Current vs. Voltage

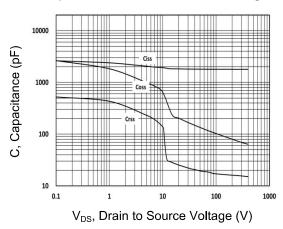




# **CHARACTERISTICS CURVES**

 $(T_C = 25^{\circ}C \text{ unless otherwise noted})$ 

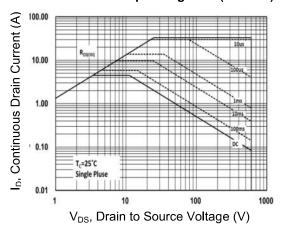
### Capacitance vs. Drain-Source Voltage



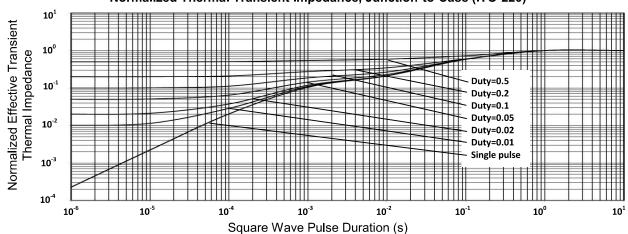
# 

T<sub>J</sub>, Junction Temperature (°C)

#### Maximum Safe Operating Area (ITO-220)

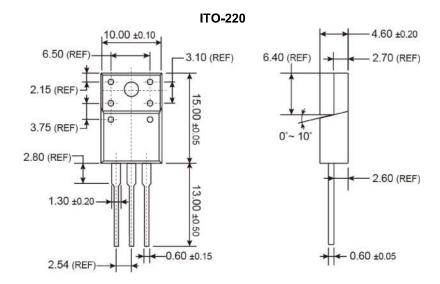


# Normalized Thermal Transient Impedance, Junction-to-Case (ITO-220)





# PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)



# **MARKING DIAGRAM**



**G** = Halogen Free

Y = Year Code

**WW** = Week Code (01~52)

F = Factory Code



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